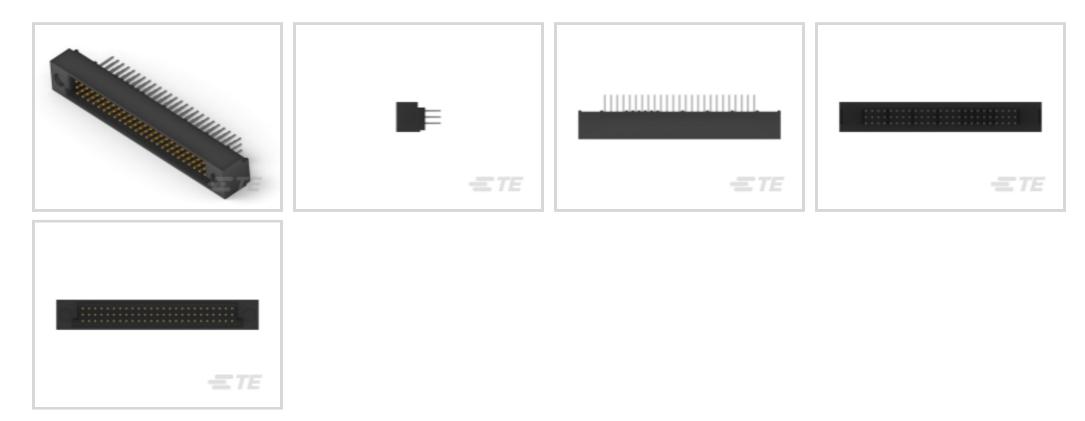
532447-1 <

AMP-HDI

TE Internal #: 532447-1 PCB Mount Header, Vertical, Board-to-Board, 75 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold (Au), Through Hole - Press-Fit, Signal

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 75

Number of Rows: 3

Features

E T E connectivity

Product Type Features

PCB Connector Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly
Configuration Features	
Stackable	No
Stackable PCB Mount Orientation	No Vertical
PCB Mount Orientation	Vertical
PCB Mount Orientation Number of Positions	Vertical 75
PCB Mount Orientation Number of Positions Number of Rows	Vertical 75

PCB Mount Header, Vertical, Board-to-Board, 75 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold (Au), Through Hole - Press-Fit, Signal



Primary Product Color	Black
Contact Features	
Mating Square Post Dimension	.64 mm[.025 in]
Contact Shape & Form	Four Beam
Contact Layout	Matrix
	.21 in
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material	Gold (Au)
Contact Type	Pin
Contact Current Rating (Max)	3 A
ermination Features	
Termination Post & Tail Length	6.35 mm[.25 in]
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Method to PCB	Through Hole - Press-Fit
lechanical Attachment	
Mating Alignment Type	Keyed

PCB Mount Retention Type	Action/Compliant Tail
PCB Mount Retention	With
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Mating Alignment	Without
Housing Features	
Housing Material	Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Connector Height	11.73 mm[.462 in]
Usage Conditions	
Housing Temperature Rating	High
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
Operation/Application	
Solder Process Feature	Board Standoff

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PCB Mount Header, Vertical, Board-to-Board, 75 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold (Au), Through Hole - Press-Fit, Signal



Circuit Application	Signal
ndustry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	7
Packaging Method	Tube
EU RoHS Directive 2011/65/EU	Not Compliant
FLL RoHS Directive 2011/65/FLL	Not Compliant
EU ELV Directive 2000/53/EC	
	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold

Halogen Content

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Not applicable for solder process capability

Solder Process Capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

PCB Mount Header, Vertical, Board-to-Board, 75 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold (Au), Through Hole - Press-Fit, Signal





Customers Also Bought



	0603	PROBE PAD	
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Documents

Product Drawings HDI PIN ASSY 3 ROW 75 POS

English

CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_532447-1_N.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_532447-1_N.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_532447-1_N.3d_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use

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PCB Mount Header, Vertical, Board-to-Board, 75 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold (Au), Through Hole - Press-Fit, Signal



Datasheets & Catalog Pages

1-1773957-5_AMP_HDI_BTB_CONNECTORS_EN

English

Product Specifications

Application Specification

English

Instruction Sheets

Instruction Sheet (U.S.)

English

Agency Approvals Agency Approval Document

English